

UNISONIC TECHNOLOGIES CO., LTD

2N90 **Preliminary Power MOSFET**

2A, 900V **N-CHANNEL POWER MOSFET**

DESCRIPTION

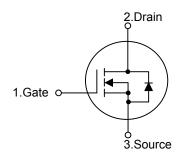
The UTC 2N90 is an N-channel mode power MOSFET using UTC's advanced technology to provide costumers with planar stripe and DMOS technology. This technology specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 2N90 is universally applied in high efficiency switch mode power supply.

FEATURES

- * $R_{DS(ON)} = 7.2\Omega @V_{GS} = 10 \text{ V}$
- * Typically 5.5 pF low C_{RSS}
- * High switching speed
- * Typically 12nC low gate charge
- * Improved dv/dt capability
- * 100% avalanche tested

SYMBOL

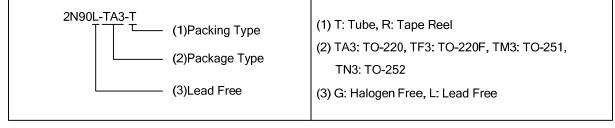


TO-252 TO-251 TO-220 TO-220F

ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
2N90L-TA3-T	2N90G-TA3-T	TO-220	G	D	S	Tube	
2N90L-TF3-T	2N90G-TF3-T	TO-220F	G	D	S	Tube	
2N90L-TM3-T	2N90G-TM3-T	TO-251	G	D	S	Tube	
2N90L-TN3-R	2N90G-TN3-R	TO-252	G	D	S	Tape Reel	
2N90L-TN3-T	2N90G-TN3-T	TO-252	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



www.unisonic.com.tw 1 of 6

■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage (Note 2)		V_{DSS}	900	٧	
Gate-Source Voltage		V_{GSS}	±30	V	
Dania Oceanant	Continuous	I_{D}	2.2	Α	
Drain Current	Pulsed (Note 2)	I _{DM}	8.8	А	
Avalanche Current (Note 2)		I _{AR}	2.2	Α	
IAValanche Energy ——	Single Pulsed (Note 3)	E _{AS}	170	mJ	
	Repetitive (Note 2)	E _{AR}	8.5	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns	
	TO-220		85	W	
Power Dissipation	TO-220F	P_{D}	25		
	TO-251/ TO-252		43		
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55~+150	°C	

- Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 - 2. Repetitive Rating: Pulse width limited by maximum junction temperature
 - 3. L = 65mH, I_{AS} = 2.2A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
 - 4. $I_{SD} \le 2.2A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220/TO-220F	0	62.5	°C/W	
	TO-251/ TO-252	θ_{JA}	110		
Junction to Case	TO-220F		1.47		
	TO-220F	$ heta_{JC}$	5	°C/W	
	TO-251/ TO-252		2.85		

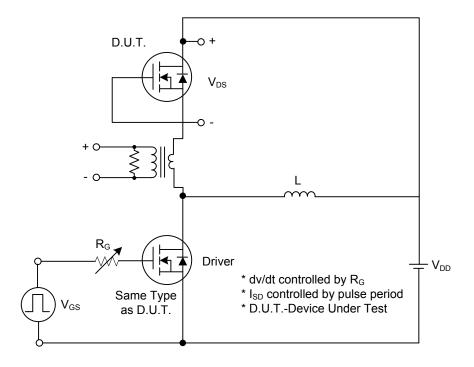
■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	$I_D=250\mu A, V_{GS}=0V$	900			V
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	Reference to 25°C, I _D =250µA		1.0		V/°C
Drain-Source Leakage Current		I _{DSS}	V _{DS} =900V, V _{GS} =0V			10	
			V _{DS} =720V, T _C =125°C			100	μA
Gate- Source Leakage Current	Forward	I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	3.0		5.0	V
Static Drain-Source On-State Re	esistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.1A		5.6	7.2	Ω
Forward Transconductance		g fs	V _{DS} =50V, I _D =1.1A (Note 1)		2.0		S
DYNAMIC PARAMETERS		_		-		-	
Input Capacitance		C _{ISS}			390	500	pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		45	60	pF
Reverse Transfer Capacitance		C _{RSS}			5.5	7.0	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_{G}	\/ -40\/ \/ -720\/ \ -2.2A		12	15	nC
Gate to Source Charge		Q_{GS}	V _{GS} =10V, V _{DS} =720V, I _D =2.2A		2.8		nC
Gate to Drain Charge		Q_{GD}	(Note 1,2)		6.1		nC
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =450V, I _D =2.2A, R _G =25Ω		15	40	ns
Rise Time		t _R			35	80	ns
Turn-OFF Delay Time		t _{D(OFF)}	(Note 1,2)		20	50	ns
Fall-Time		t _F			30	70	ns
SOURCE- DRAIN DIODE RATII	NGS AND CH	ARACTERISTI	CS				
Maximum Continuous Drain-Source Diode						2.2	Α
Forward Current		I _S				2.2	^
Maximum Pulsed Drain-Source Diode		I _{SM}				8.8	Α
Forward Current		ISM				0.0	^
Drain-Source Diode Forward Voltage		V _{SD}	I _S =2.2A, V _{GS} =0V			1.4	V
Reverse Recovery Time		t _{rr}	I_S =2.2A, V_{GS} =0V, dI_F / dt =100A/ μ s		400		ns
Reverse Recovery Charge		Q_{RR}	(Note 1)		1.6		μC

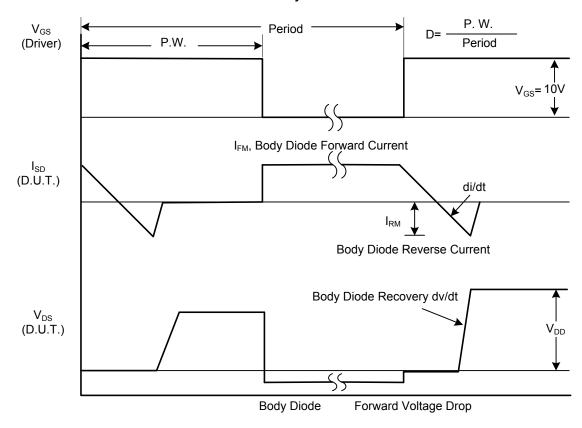
Note: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

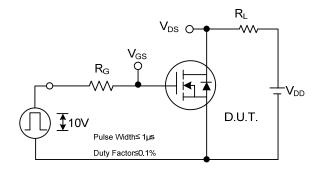


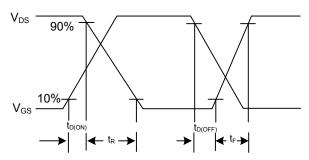
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

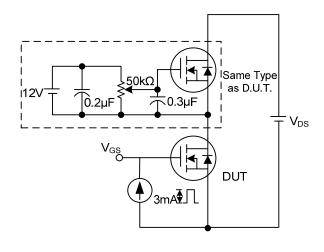
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

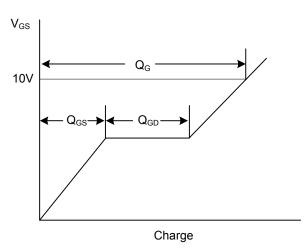




Switching Test Circuit

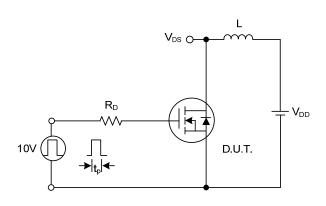
Switching Waveforms

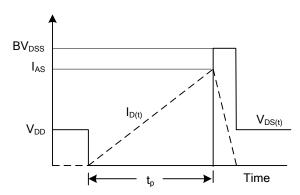




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

